

10/540528

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Application Data Sheet

Application Information

Application Type:: Regular
Subject Matter:: National Phase
Suggested Group Art Unit:: N/A
CD-ROM or CD-R?:: None
Sequence submission?:: None
Computer Readable Form (CRF)?:: No
Title:: CURABLE RESIN COMPOSITION AND
CURED PRODUCT
Attorney Docket Number:: 4924-0112PUS1
Request for Early Publication?:: No
Request for Non-Publication?:: No
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
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Status:: Full Capacity
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Correspondence Customer Number:: 02292

Representative Information

Representative Customer Number:: 02292

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP2003/016568	12/24/03

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-381563	12/27/02	Yes

Assignee Information

Assignee name:: Daicel Chemical Industries, Ltd.

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